

SN74ALVC16269

12-BIT TO 24-BIT REGISTERED BUS TRANSCEIVER WITH 3-STATE OUTPUTS

SCAS417A – OCTOBER 1993 – REVISED OCTOBER 1994

- **EPIC™ (Enhanced-Performance Implanted CMOS) Submicron Process**
- **Member of the Texas Instruments Widebus™ Family**
- **Supports Unregulated Battery Operation Down to 2.7 V**
- **Typical V_{OLP} (Output Ground Bounce) < 0.8 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$**
- **Typical V_{OHV} (Output V_{CC} Overshoot) > 2 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$**
- **Bus Hold On Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors**
- **Packaged in Plastic Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages**

description

The SN74ALVC16269 is a 12-bit to 24-bit registered bus transceiver, which is intended for applications where two separate ports must be multiplexed onto, or demultiplexed from, a single port. It is particularly suitable as an interface between synchronous DRAMs and high-speed microprocessors. The SN74ALVC16269 is designed specifically for low-voltage (3.3 V) V_{CC} operation.

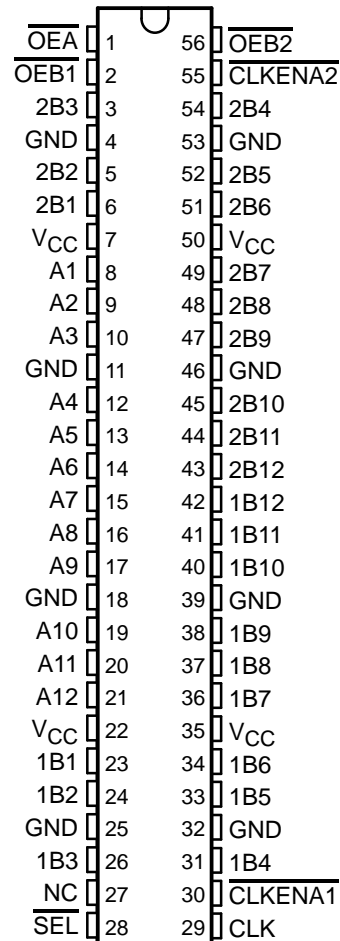
Data is stored in the internal B-port registers on the low-to-high transition of the clock (CLK) input, provided that the appropriate clock-enable (CLKENA) inputs are low. Proper control of these inputs allows two sequential 12-bit words to be presented as a 24-bit word on the B port. For data transfer in the B-to-A direction, a single storage register is provided. The select ($\overline{\text{SEL}}$) line selects 1B or 2B data for the A outputs. The register on the A output permits the fastest possible data transfer, thus extending the period that the data is valid on the bus. The control terminals are registered so that all transactions are synchronous with the clock. Data flow is controlled by the active-low output enables ($\overline{\text{OEA}}$, $\overline{\text{OEB1}}$, $\overline{\text{OEB2}}$).

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN74ALVC16269 is available in TI's shrink small-outline (DL) and thin shrink small-outline (DGG) packages, which provide twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The SN74ALVC16269 is characterized for operation from -40°C to 85°C .

DGG OR DL PACKAGE
(TOP VIEW)



NC – No internal connection

PRODUCT PREVIEW

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Function Tables

OUTPUT ENABLE

INPUTS			OUTPUTS	
CLK	$\overline{\text{OEA}}$	$\overline{\text{OEB}}$	A	1B, 2B
↑	H	H	Z	Z
↑	H	L	Z	Active
↑	L	H	Active	Z
↑	L	L	Active	Active

A-TO-B STORAGE ($\overline{\text{OEB}} = \text{L}$)

INPUTS				OUTPUTS	
$\overline{\text{CLKENA1}}$	$\overline{\text{CLKENA2}}$	CLK	A	1B	2B
H	H	X	X	1B ₀ [†]	2B ₀ [†]
L	X	↑	L	L	X
L	X	↑	H	H	X
X	L	↑	L	X	L
X	L	↑	H	X	H

B-TO-A STORAGE ($\overline{\text{OEA}} = \text{L}$)

INPUTS				OUTPUT
CLK	$\overline{\text{SEL}}$	1B	2B	A
X	H	X	X	A ₀ [†]
X	L	X	X	A ₀ [†]
↑	H	L	X	L
↑	H	H	X	H
↑	L	X	L	L
↑	L	X	H	H

† Output level before the indicated steady-state input conditions were established.

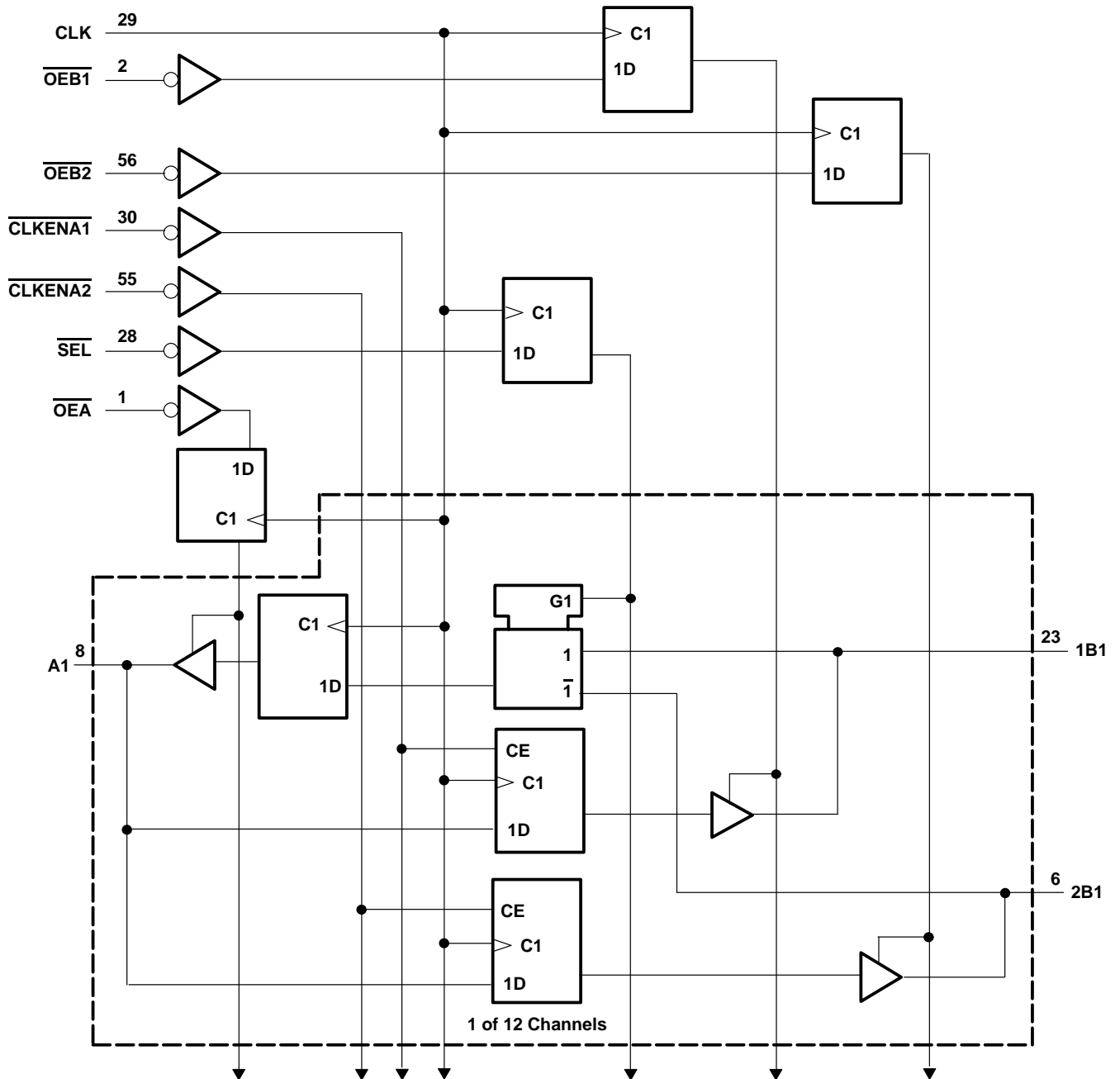
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logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	–0.5 V to 4.6 V
Input voltage range, V_I (except I/O ports) (see Note 1)	–0.5 V to $V_{CC} + 0.5$ V
Input voltage range, V_I (I/O ports) (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Output voltage range, V_O (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	–50 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±50 mA
Continuous current through V_{CC} or GND	±100 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 3): DGG package	1 W
DL package	1.4 W
Operating free-air temperature range, T_A	–40°C to 85°C
Storage temperature range	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 2. This value is limited to 4.6 V maximum.
 3. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note in the 1994 *ABT Advanced BiCMOS Technology Data Book*, literature number SCBD002B.

recommended operating conditions

			MIN	MAX	UNIT
V _{CC}	Supply voltage		2.7	3.6	V
V _{IH}	High-level input voltage	V _{CC} = 2.7 V to 3.6 V	2		V
V _{IL}	Low-level input voltage	V _{CC} = 2.7 V to 3.6 V		0.8	V
V _I	Input voltage		0	V _{CC}	V
V _O	Output voltage		0	V _{CC}	V
I _{OH}	High-level output current	V _{CC} = 2.7 V		−12	mA
		V _{CC} = 3 V		−24	
I _{OL}	Low-level output current	V _{CC} = 2.7 V		12	mA
		V _{CC} = 3 V		24	
Δt/Δv	Input transition rise or fall rate		0	10	ns/V
T _A	Operating free-air temperature		−40	85	°C

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V _{CC} [†]	MIN	MAX	UNIT
V _{OH}		I _{OH} = –100 μA	MIN to MAX	V _{CC} –0.2		V
		I _{OH} = –12 mA	2.7 V	2.2		
			3 V	2.4		
		I _{OH} = –24 mA	3 V	2		
V _{OL}		I _{OL} = 100 μA	MIN to MAX	0.2		V
		I _{OL} = 12 mA	2.7 V	0.4		
		I _{OL} = 24 mA	3 V	0.55		
I _I	Inputs	V _I = V _{CC} or GND	3.6 V	±5		μA
I _I (hold)	Data pins	V _I = 0.8 V	3 V	75		μA
		V _I = 2 V		–75		
I _{OZ}		V _O = V _{CC} or GND	3.6 V	±10		μA
I _{CC}		V _I = V _{CC} or GND, I _O = 0	3.6 V	40		μA
ΔI _{CC}		V _{CC} = 3 V to 3.6 V, One input at V _{CC} – 0.6 V, Other inputs at V _{CC} or GND		750		μA
C _i		V _I = V _{CC} or GND	3.3 V			pF
C _{io}		V _O = V _{CC} or GND	3.3 V			pF

[†] For conditions shown as MIN or MAX, use the appropriate values under recommended operating conditions.

operating characteristics, T_A = 25° C

PARAMETER			TEST CONDITIONS	V _{CC} = 2.5 V ± 0.2 V	V _{CC} = 3.3 V ± 0.3 V	UNIT
				TYP	TYP	
C _{pd}	Power dissipation capacitance	Outputs enabled	C _L = 50 pF, f = 10 MHz	64	71	pF
		Outputs disabled		36	39	

PRODUCT PREVIEW



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